Our History

1946-1965

A New Light for People and for Society

Our manufacturing started with the recycling business of household lightbulbs in post-war Japan. In anticipation of a new era, we focused all of our efforts on developing new products. This effort is the source of our current technological innovation.

1946

- · Established Nagano Katei Denki Saisei-jo as a limited partnership
- Reorganized and renamed Nagano Katei Denki Saisei-jo, creating SHINKO ELECTRIC INDUSTRIES CO., LTD.

1949

 Began supplying No.2 lamps to the Japan Ministry of Telecommunications (now NTT, Inc.)



1953

· Began manufacturing glass-to-metal seals for diodes

1957

- Obtained equity participation from Fujitsu Ltd., to expand into the field of semiconductors
- Opened the Kurita Plant in Nagano City, Nagano Prefecture



1959

 Began manufacturing glass-to-metal seals for transistors



1960

 $\cdot \textbf{Formed the SHINKO WORKERS UNION}$

1963

Opened the Kohoku Plant in Kohoku Village, Sarashina-gun(now Oshimada-machi, Nagano City), Nagano Prefecture



1966-1985

Supporting the Development of Semiconductor Industry, and Expanding Business Globally

We made full use of semiconductor packaging technologies to steadily expand the business fields. It was in this era that our business expanded overseas rapidly.

1966

Began manufacturing DIP-10 packages, marking the start of IC package production by the Company

1968

·Began manufacturing leadframes

1977

 Established SHINKO ELECTRIC AMERICA, INC. in the US state of California

1978

· Opened the Arai Plant in Arai City (now Myoko City), Niigata Prefecture

1979

·Began IC assembly

1980

 Opened the Takaoka Plant in Nakano City, Nagano Prefecture



1982

Began manufacturing glass-to-metal seals for laser diodes

1984

 Listed shares on the Second Section of the Tokyo Stock Exchange

1986-2005

Keeping Up with the Challenges of Accelerating Digital Technology

It is in our DNA to make the dreams of our customers a reality in the drive to satisfy market needs, under the environment where semiconductors continue to evolve smaller, thinner, and lighter.

1987

· Established KOREA SHINKO MICROELECTRONICS Co., Ltd.

1990

· Established SHINKO ELECTRONICS (MALAYSIA) SDN.BHD.

1991

Opened the Wakaho R&D Center (now the Wakaho Plant) in Nagano City, Nagano Prefecture

1993

 Opened the Kyogase Plant in Kyogase Village (now Agano City), Niigata Prefecture



1994

 Established the Environmental Charter (later renamed the "Environmental Policy")

1995

· Began manufacturing PLP (Plastic Laminated Package)

1996

 Listed shares on the First Section of the Tokyo Stock Exchange



1998

• Takaoka Plant gains the ISO 14001 international environmental management certification Other plants later gained the same certification as well

2002

· Opened the SHINKO R&D Center in Kitaowaribe, Nagano City (within the former Nagano Plant of Fujitsu Ltd.)

2004

· Announced the opening of the Kurita Sogo Center. (formerly the Kurita Plant)



2006-2025

Supporting the Innovation of Semiconductors Towards the Next Generation

Semiconductor technology that brings innovation in society. We pursue the highest level of manufacturing and technology and continuously strive to develop the latest innovations.

2010

- · Established the Shinko Way
- Began large-scale production of DLL3[®] Coreless Substrates (an industry-first)

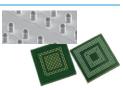


2013

· Began large-scale production of PBGA Thin Substrates (Coreless)

2014

- ·Began large-scale production of Cu pillars
- ·Began large-scale production of MCePs



2017

· Announced a Joint Labor Management Declaration on Transforming Work Styles

2021

·Opened the SHINKO Techno Academy

2022

- · Established the Environmental Vision 2050
- Moved to the Prime Market due to the restructuring of the Tokyo Stock Exchange market



2023

 Opened the Chikuma Plant in Chikuma City, Nagano Prefecture



2025

• Delisted the shares with JICC Consortium as a new partner

Advancing to a new stage of further growth